Panasonic SD Memory Offers the High Reliability Demanded for Industrial/automotive Use

High Reliability and Panasonic Controller Technology

Data Programming and Erase Endurance

Wear Levelling

Maximising SD Memory Life

Static wear levelling controls written data, including fixed data. Various use cases eliminate intensive data writing and maximise the lifetime of the SD card.



Intelligent Data Writing

Durable Performance

• Dispersion of Writing Stress to NAND Flash Memory Intelligent data writing disperses the writing stress to NAND flash memory, to reduce program disturbances.

Secure Storage

Bit Error Auto Refresh

• Withstanding Repeated Reading Operations

Automatically refreshes the bit errors that accumulate over time, before they exceed the threshold. (Accumulated bit errors are detected from read data.)

* This function does not guarantee permanent data retention.



Power Failure Robustness

Recovery

• Protects saved data and device

Unique Panasonic algorithms minimise data damage in the event of a power interruption. Even in the event that an error is generated, the controller recovers the data, restoring it to the condition prior to the error, and preventing errors from reaching the entire SD memory area.

* Power Fail Robustness Mode firmware also available for more robust MLC system

Panasonic SD memory features high endurance	Temperature Resistance	Electrostatic Resistance	Impact Resistance	
against static electricity, magnetism, and X-rays.	Operation is assured even under harsh temperature conditions. A usable temperature range of -40 °C to 85 °C maintains stable performance everywhere, from extremely cold to intensely hot climates.	ICE 61000-4-2 compliance: Clears Electrostatic Discharge Immunity Tests of 150-pF energy storage capacitance, 15-kV aerial discharge, and 330-Ω discharge resistance.	High endurance against bending and twisting. Bending load resistance 20 N (Newton) min. (SD standard: 10 N) Twisting torque resistance 0.3 N•m (Newton meter) min. (SD standard: 0.15 N•m)	
Magnetic Resistance	X-Ray Resistance	Water Resistance	Built-in Fuse	
Minimal damage from magnetic forces. Operable after being set onto a 1,000-gauss DC magnetic field for approx. 1 minute.	Data is protected from X-rays. ISO 7816-1 compliance: Operable after 0.1 Gy (gray) of X-ray irradiation.	JIS IPX7 compliance: Operable after submerging the product in water (tap water, 1-m depth) for 30 minutes. * micro SD – Excluding SD adaptor use. * Card only.	The internal card fuse protects against excess current and abnormal heating. Even if excess current or abnormal heating were to occur due to internal card damage caused by the device being used or the environment, the built-in fuse will operate to prevent the SD Memory Card from overheating or igniting.	

Applications by Model

	Data Protection•						С	ard Enduran	се		
	Wear Levelling	Intelligent Data Writing	Refresh	Recovery	Temperature Resistance	Electrostatic Resistance	Impact Resistance	Magnetic Resistance	X-Ray Resistance	Water Resistance	Fuse
FX Series			٠	٠		•	•	•	•	—	٠
P Series		•	•				•	•	•	—	٠
microSD/ KC Series	•	•	•	•	-40 °C	•	•	•	•	•	•
microSD/JC Series			٠		+85 °C		•	•	•		٠
eSD (Flexible connection type)			•	•			•	•	•	—	_
eSD (Semiconductor mounting type)			•				•	•	•	—	_

* Based on Panasonic test results. Protection may not be possible in certain usage environments. The data stored inside a card cannot be guaranteed

SD Memory Card Roadmap 2 TB 🔺 (Capacity) SŽ HC 64 GB SDHC Memory Card 32 GB Parameter 1 See 6 3208 32 GB S 16 GB 8 GB SD Memory Card 4 GB Parameter 1 and 6 4 cm 2 GB 1 50 B 208 2 GB Max. 22 MB/s tandard spee

What is UHS-I?

~2005

UHS-I (Ultra High Speed I) is a speed specification for SD Memory Cards that was established in 2010. Its features include a maximum bus interface speed of up to 104 MB/s. It utilizes conventional SD design assests and offers enhanced speeds. Three different modes (DDR50, SDR50 and SDR104) have been standardized for the UHS-I based on the application and objective.

2007

Speed Specification and Performance 2010 of SD Memory Cards

2006

(Years indicate the year that the standard was established.)

2006 HS (High Speed) 25MB/s CLASS (0)

2008

				(Class 2,4,6 were established in 2006)
nterface Standard	Conventional		UHS-I	
Mode	HS	DDR50	SDR50	SDR104
nal Amplitude	3.3 V Amplitude		1.8 V Amplitude	
ock Frequency	50 MHz	50 MHz	100 MHz	208 MHz
ata Frequency	50 MHz	100 MHz	100 MHz	208 MHz
ic Performance (Bus Speed)	25 MB/s	50 MB/s	50 MB/s	104 MB/s

Bus Interface Standard	Conventional	UHS-I			
Mode	HS	DDR50	SDR50	SDR104	
Signal Amplitude	3.3 V Amplitude	1.8 V Amplitude			
Clock Frequency	50 MHz	50 MHz	100 MHz	208 MHz	
Data Frequency	50 MHz	100 MHz	100 MHz	208 MHz	
Logic Performance (Bus Speed)	25 MB/s	50 MB/s	50 MB/s	104 MB/s	

Product Precautions

• SDHC memory cards can be used with SDHC and SDXC host products. SDHC memory cards cannot be used with products that are solely compliant with SD memory cards.

• SDXC memory cards can be used only with SDXC host products. SDXC memory cards cannot be used with SD and SDHC host products. Check if the device has an SDXC logo, or refer to the device's instruction manual or other manufacturer's information Please note that using an SDXC Memory Card in a non-compatible computer or device may cause card compatibility problems or loss of data.

• The SD Memory Card is intended for ordinary use in for home or professional devices and embedded systems. Consult with Panasonic in advance about uses for applications that require a high degree of reliability (uses that may have a serious impact on human lives, such as in nuclear power or social infrastructure applications.)

- For more information -

http://panasonic.net/avc/sdcard/industrial_sd/

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Panasonic ideas for life

2013 Vol.1

Endurance

Industrial/Automotive SD Memory

Extended

Temperature



• Specifications for industrial/automotive applications demanding high reliability.

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- Various customization to meet customer requirements.
- B-to-B specialised support provided.

Panasonio

Migro Leite I

16gb

Made in Japar





SD Memory

Industrial/Automotive Use SD Memory Line-up

1

CLASS(10)





Model		RP-SMKC04	RP-SMKC08	RP-SMKC16		
Capacity ^{*1} 4 GB			8 GB	16 GB		
Flash Memory	Туре	Multi-Le	vel Cell (MLC) NAND Flash	Memory		
SD Physical Specificati	ion		Ver. 3.01 (UHS-I Compliant))		
Speed Class		SD Speed Class 10, UHS Speed Class 1				
Transfer Rate Read		45 MB/s				
(Max)* ²	Write	12 MB/s				
Operating Temperature	e		-40 to +85 °C			
		by Panasonic				
Controller	Functions	Static Wear Levelling, Intelligent Data Writing, Recovery Function from Power Failure, Refresh Function				
Size		15.0 x 11.0 mm (Max)				
1: SD Memory utilise a portion of the memory for conv protection and other purposes. Therefore Lisable canacity will be less. *2: Speed performance is subject				d performance is subject to change.		

Performance Specifications

RP-SDF02G

Model		RP-SDF02G	RP-SDF04G	RP-SDF08G	RP-SDF16G	
Capacity*1		2 GB	4 GB	8 GB	16 GB	
Flash Memory	Туре		Single-Level Cell (SLC) NAND Flash Memory		
SD Physical Specification		Ver.3.01 (No UHS-I Compliant)	Ver. 3.01 (UHS-I Compliant)			
Speed Class		SD Speed Class 6	ed Class 6 SD Speed Class10, UHS Speed Class 1			
Transfer Rate	Read	22 MB/s	90 MB/s	95 N	//B/s	
(Max)*2	Write	20 MB/s	20 MB/s 40 MB/s 80 MB/s		//B/s	
Operating Temperature -40 to +85 °C						
Controller		by Panasonic				
Functions Static Wear Levelling, Intelligent Data Writing, Recovery Function from Power Failure, Refre					Failure, Refresh Function	
Size 32.0 x 24.0 n				24.0 mm		

RP-SDF04G

RP-SDF08G

RP-SDF16G*

* Release date under consideration *1: SD Memory utilise a portion of the memory for copy protection and other purposes. Therefore Usable capacity will be less. *2: Speed performance is subject to change.



Performance Specifications

-						
Model		RP-SDP04G	RP-SDP08G	RP-SDP16G		
Capacity*1		4 GB	8 GB	16 GB		
Flash Memory	Туре	Multi-Level Cell (MLC) NAND Flash Memory				
SD Physical Specification	Ver.3.01 (No UHS-I Compliant)			nt)		
Speed Class		SD Speed Class 4				
Transfer Rate (Max)*2	Read	Read 22 MB/s				
Operating Temperature -40 to +85 °C		-40 to +85 °C				
		by Panasonic				
Controller	Functions	Static Wear Levelling, Intelligent Data Writing, Recovery Function from Power Failure, Refresh Function				
Size		32.0 x 24.0 mm				

★ Release date under consideration *1: SD Memory utilise a portion of the memory for copy protection and other purposes. Therefore Usable capacity will be less. *2: Speed performance is subject to change





RP-SMKC16



MLC

Model		RP-SD04GP	RP-SD08GP	RP-SD16GP		
Capacity*1		4 GB	8 GB	16 GB		
Flash Memory	Туре	Multi-Lev	el Cell (MLC) NAND Flash	Memory		
SD Physical Specification		Ver. 3.01 (No UHS-I Compliant)				
Speed Class		SD Speed Class 4				
Transfer Rate (Max)*2	Read	22 MB/s				
Operating Temperature		-40 to +85 °C				
Controller		by Panasonic				
Controller	Functions	Static Wear Levelling, Intelligent Data Writing, Recovery Function from Power Failure, Refresh Function				
Size		30.0 x 24.0 mm				

RP-SD08GP

(8 GB)

*1: SD Memory utilise a portion of the memory for copy protection and other purposes. Therefore Usable capacity will be less. *2: Speed performance is subject to change

eSD (Semiconductor Mounting Type) MLC

eSD (Flexible Connection Type)



Performance Specifications							
Model		RP-SVBC04	RP-SVBC08	RP-SVBC16			
Capacity*1		4 GB	8 GB	16 GB			
Flash Memory	Туре	Multi-Le	vel Cell (MLC) NAND Flash	Memory			
SD Physical Specification	า		Ver. 3.01 (UHS-I Compliant	t)			
Speed Class		SD Speed Class 10, UHS Speed Class 1					
Transfer Rate	Read	90 MB/s					
(Max)*2	Write	12 MB/s					
Operating Temperature			-40 to +85 °C				
		by Panasonic					
Controller	Functions	Static Wear Levelling, Intelligent Data Writing, Recovery Function from Power Failure, Refresh Function					
Size			18.0 x 12.2 mm				

*1: SD Memory utilise a portion of the memory for copy protection and other purposes. Therefore Usable capacity will be less. *2: Speed performance is subject to change.

Applicable EMC Standards Environmental Specifications (Common to all models) 1) VCCI Class B (Option B) 2) FCC Part 15 Class B (Verification) -40 to +85 °C Vibration 15 Gp-p Tempe (Operating) 3) EC Directive 89/336/EEC -rature (Non-operating) -40 to +85 °C (1,000 h) Shock 1,000 G EN55022: 2006 Class B 5 to 95 % (No condensation) Humidity RoHS Directive Compatibility EN55024: 1998 +A1: 2001 +A2: 2003 4) AS/NZS CISPR Pub22: 2006

· Panasonic industrial/automotive use SD memory has a unique Panasonic function that reports data such as bad blocks, writing cycles, and the SD memory internal connection status.

· A special B to B support system also allows Panasonic to offer consultation concerning customisation upon customer request.

Products converted to SLC are also available on demand. Form factor of module can be customized.

RP-SD16GP (16 GB)





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